

Sourcelight

# XFP Bi-Directional 10G 80km Tx1490/Rx1550nm & Tx1550/Rx1490nm

SLXFB-XXXX-80



### **Description**

Sourcelight SLXFB-XXXX-80 is XFP BIDI 80KM transceivers are designed for 10G Ethernet 10G BASE-LR/LW per 802.3ae and 10G SOI OC-192/SDH STM-64, and it can support data-rate from 9.953Gb/s to 11.1Gb/s.Digital diagnostics are avail-able via I2C interface as specified in the XFP MSA.

The transceiver designs are optimized for high per-formance and cost effective to supply customers the best solutions for data-com and telecom applications.

#### **Features**

- XFP MSA package with single LC connector
- Typical bidi 1490/1550nm and 1550nm/1490nm for commission
- APD receiver for high sensitivity
- Hot pluggable
- Support 9.95Gb/s to 11.1Gb/s bit rates
- Digital Diagnostic Monitor Interface
- Very low EMI and excellent ESD protection
- ◆ +3.3V single power supply
- ♦ Below <1.5w power consumption
- operating temperature range 0°C to 70°C
- No reference clock requirement

### **Applications**

- ◆ 10GBASE-BX 10.3125Gb/s Ethernet
- ◆ 10GBASE-BX 9.953Gb/s Ethernet
- ◆ SONET OC-192 & SDH STM I-64.1

## **Ordering information**

Part Number	Product Description
SLXFB-4955-80	XFP BIDI 10Gbps, 1490nm Transmitter and 1550nm Receiver, 80km, 0ºC ~ +70ºC
SLXFB-5549-80	XFP BIDI 10Gbps, 1550nm Transmitter and 1490nm Receiver, 80km, 0°C ~ +70°C

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# **Absolute Maximum Ratings**

Parameter		Symbol	Min	Труе	Max	Unit	Ref.
Storage Ambient Temperature Range			-40		+85	°C	
Powered case Temperature Range			0		+70	°C	
Operating Relative Humidity		RH			85	%	
Data Rate	Ethernet			10.3125		Gb/s	
	Fiber Channel			9.953		Gb/s	

# **Electrical Characteristics**

Parameter		Symbol	Min	Typical	Max	Unit	Note		
Operating Case Temperature Range		Тс	0		+70	°C			
Power Supply Voltage @	9.3V	Vcc3	3.13	3.3	3.47	V			
Supply Current		Icc			450	mA			
Transmitter									
Parameter		Symbol	Min.	Тур	Max.	Unit	Note		
Diff. input voltage swing			120		820	mVpp	1		
Ty Disable input	Н	VIH	2.0		Vcc+0.3	V			
Tx Disable input	L	VIL	0		0.8				
Ty Fault output	Н	VOH	2.0		Vcc+0.3	V	2		
Tx Fault output	L	VOL	0		0.8				
Input Diff. Impedan	Input Diff. Impedance			100		Ω			
Receiver									
Parameter		Symbol	Min.	Тур	Max.	Unit	Note		
Diff. output voltage swing			340	650	800	mVpp	3		
Rx LOS Output	Н	VOH	2.0		Vcc+0.3	V	2		
KX LOS Output	L	VOL	0		0.8		2		

#### Notes:

1. Note 1) TD+/- are internally AC coupled with  $100\Omega$  differential termination inside the module.

2. Note 2) Tx Fault and Rx LOS are open collector outputs, which should be pulled up with 4.7k to 10kΩ resistors on the host board. Pull up voltage between 2.0V and Vcc+0.3V.

3. Note 3) RD+/- outputs are internally AC coupled, and should be terminated with  $100\Omega$  (differential) at the user SERDES.

# **Optical Characteristics**

Symbol	Min	Typical	Max	Unit	Ref.			
Transmitter								
T1490/R1550	1480	1490	1500	nm	1			
T1550/R1490	1540	1550	1560					
Ро	+1		+6	dBm	2			
ER	5			dB	2			
Δλ			1	nm				
Tr/Tf			50	ps	3			
	T1490/R1550 T1550/R1490 Po ER Δλ	Transmitter    T1490/R1550  1480    T1550/R1490  1540    Po  +1    ER  5    Δλ	Transmitter    T1490/R1550  1480  1490    T1550/R1490  1540  1550    Po  +1     ER  5     Δλ	Transmitter    T1490/R1550  1480  1490  1500    T1550/R1490  1540  1550  1560    Po  +1  +6    ER  5  1    Δλ  1  1	Transmitter  1480  1490  1500  nm    T1490/R1550  1480  1490  1500  nm    T1550/R1490  1540  1550  1560     Po  +1  +6  dBm    ER  5   dB    Δλ  1  nm			



Optical modulation amplitude	OMA	-4.8			dBm				
Dispersion penalty				3	dB				
Output Optical Eye	IEEE 802.3-2005 Co	ompliant							
	Receiver								
Operating Wavelength	T1550/R1490	1540	1550	1560	nm	1			
Operating wavelength	T1490/R1550	1480	1490	1500		T			
Sensitivity	Psen			-24	dBm	4			
Min. overload	Pimax	-7			dBm				
LOS Assert	Ра	-40			dBm				
LOS De-assert	Pd			-22	dBm				
LOS Hysteresis	Pd-Pa	0.5		4	dB				

Notes:

1. Note 1) 1470nm~1610nm transmitter, minimum interval 60nm.

2. Note 2) Measured at 10.3125b/s with PRBS 231 - 1 NRZ test pattern.

3. Note 3)20%~80%

4. Note 4)Under the ER worst case, measured at 10.3125 Gb/s with PRBS 231 - 1 NRZ test pattern for BER < 1x10-12

## **Hostboard Connector Pinout**

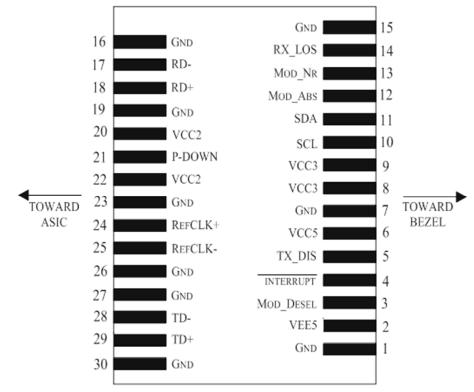


Figure 1: Electrical Pin-out Details



# **Pin Descriptions**

Pin	Logic	Symbol	Name/Description	Ref
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to, respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply– Not required	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock	2
11	LVTTL- I/O	SDA	Serial 2-wire interface data line	2
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTL-O	Mod_NR	Module Not Ready;	2
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply	
21		D. Deurs (DCT	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
21	LVTTL-I	P_Down/RST	Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – Not required	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1
Notes:				

#### Notes:

1. Module circuit ground is isolated from module chassis ground within the module.

2. Open collector; should be pulled up with 4.7k - 10k ohms on host board to a voltage between 3.15V and 3.6V.

3. A Reference Clock input is not required.



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Datasheet

## Management Interface

The XFP modules implement the 2-wire serial communication protocol as defined in the XFP MSA. The serial ID information of the XFP modules and Digital Diagnostic Monitor parameters can be accessed through the I2C interface at address A0h and A2h.

The memory is mapped in Table 1. Detailed ID information(A0h) And the DDM specification(A2h). For more details of the memory map and byte definitions, please refer to the SFF-8472 (Rev 9.3, Aug. 2002), "Digital Diagnostic Monitoring Interface for Optical Transceivers".

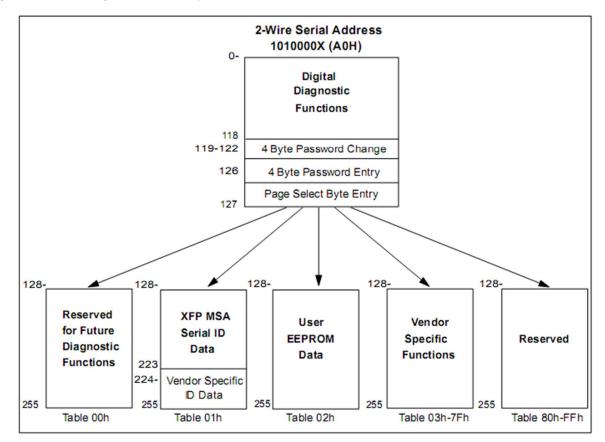
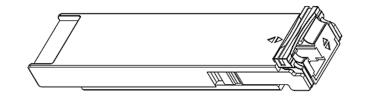


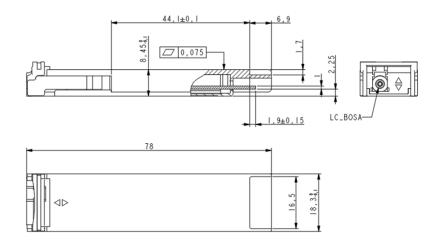
Figure 2: Digital Diagnostic Memory Map



## **Mechanical Specifications**

XFP transceivers are compliant with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).





#### Figure3. Mechanical Specifications

#### Shenzhen Sourcelight Technology Co., Ltd

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